## **EXHIBIT D**

## IN THE UNITED STATES DISTRICT COURT FOR THE WESTERN DISTRICT OF TEXAS WACO DIVISION

DEMARAY LLC,  Plaintiff  -v-  INTEL CORPORATION,  Defendant	§ W-20-CV-00634-ADA § § § § § § § § § § § § § § § § § §
DEMARAY LLC,  Plaintiff  -v-  SAMSUNG ELECTRONICS CO., LTD. (A KOREAN COMPANY), SAMSUNG ELECTRONICS AMERICA, INC., SAMSUNG SEMICONDUCTOR, INC., SAMSUNG AUSTIN SEMICONDUCTOR, LLC,  Defendants	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$

## **CLAIM CONSTRUCTION ORDER**

The Court held a supplemental *Markman* hearing on February 28, 2022. During that hearing, the Court provided its final constructions. The Court now enters those claim constructions.

**SIGNED** this 28th day of February, 2022.



Term	Plaintiff's Proposed Construction	Defendants' Proposed Construction	Court's Final Construction
"A method of depositing an insulating film on a substrate, comprising:"  U.S. Patent No. 7,381,657, Claim 2	Preamble is not limiting, except for "insulating film on a substrate"	Preamble is limiting ("depositing an insulating film on a substrate")	Preamble is not limiting, except for "insulating film on a substrate"
"wherein an oxide material is deposited on the substrate, and the insulating film is formed by reactive sputtering in a mode between a metallic mode	Plain and ordinary meaning	"wherein an oxide material is deposited on the substrate and the insulating film comprising the oxide material is formed by reactive sputtering between a	Plain-and-ordinary meaning
and a poison mode."  U.S. Patent No. 7,381,657, Claim 2		metallic mode and a poison mode"	